PMB:iar 11/13/06 1011-67627-01 610396

Attorney Docket Number	lumber   1011-67627-01		
Application Number	10/781,031		
Filing Date	February 17, 2004		
First Named Inventor	Rajski		
Art Unit	2193		
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## U.S. PATENT DOCUMENTS

Copies of U.S. Patent documents do not need to be provided, unless requested by the Patent and Trademark Office. For patents, provide the patent number and the issue date. For published U.S. applications, provide the publication number and the publication date. For unpublished pending patent applications, provide the application number and the filing date.

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	EXAMINER SIGNATURE:	/David Malzahn/	DATE CONSIDERED:	12/13/2006
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